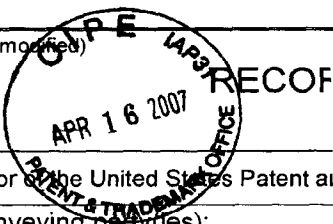


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5. Name and address of party to whom correspondence concerning document should be faxed:

**George C. Beck  
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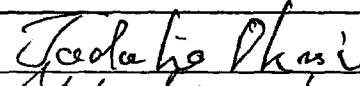
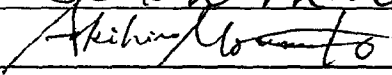
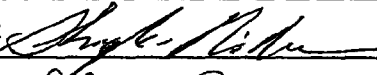
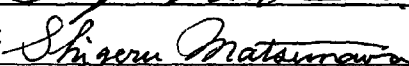
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